Power TOPLED with Lens
Hyper-Bright LED

LA E655

Vorläufige Daten / Preliminary Data

Besondere Merkmale

- **Gehäusetyp:** weißes P-LCC-4-Gehäuse
- **Besonderheit des Bauteils:** fokussierte Abstrahlung in SMT-Technologie; hohe Helligkeit in Achsrichtung
- **Wellenlänge:** 617 nm (amber)
- **Abstrahlwinkel:** 60°
- **Technologie:** InGaAlP
- **optischer Wirkungsgrad:** 15 lm/W
- **Gruppierungsparameter:** Lichtstärke, Durchflussspannung
- **Verarbeitungsmethode:** für alle SMT-Bestücktechniken geeignet
- **Lötmethode:** IR Reflow Löten und Wellenlöten (TTW)
- **Vorbehandlung:** nach JEDEC Level 2
- **Gurtung:** 12-mm Gurt mit 2000/Rolle, ø330 mm
- **ESD-Festigkeit:**ESD-sicher bis 2 kV nach EOS/ESD-5.1-1993

Features

- **package:** white P-LCC-4 package
- **feature of the device:** focussed radiation in SMT technology; high brightness in beam direction
- **wavelength:** 617 nm (amber)
- **viewing angle:** 60°
- **technology:** InGaAlP
- **optical efficiency:** 15 lm/W
- **grouping parameter:** luminous intensity, forward voltage
- **assembly methods:** suitable for all SMT assembly methods
- **soldering methods:** IR reflow soldering and TTW soldering
- **preconditioning:** acc. to JEDEC Level 2
- **taping:** 12-mm tape with 2000/reel, ø330 mm
- **ESD-withstand voltage:** up to 2 kV acc. to EOS/ESD-5.1-1993

Anwendungen

- Ampelanwendung
- Hinterleuchtung (LCD, Schalter, Tasten, Displays, Werbebeleuchtung)
- Innen- und Außenbeleuchtung im Automobilbereich (z.B. Instrumentenbeleuchtung und Bremslichter)
- Ersatz von Kleinst-Glühlampen
- Markierungsbeleuchtung (z.B. Stufen, Fluchtwege, u.ä.)
- Signal- und Symbolleuchten

Applications

- traffic lights
- backlighting (LCD, switches, keys, displays, illuminated advertising)
- interior and exterior automotive lighting (e.g. dashboard backlighting and brake lights)
- substitution of micro incandescent lamps
- marker lights (e.g. steps, exit ways, etc.)
- signal and symbol luminaire

Typ Type	Emissions-farbe Color of Emission	Farbe der Lichtaustritts-fläche Color of the Light Emitting Area	Lichtstärke Luminous Intensity I_F = 50 mA I_V (mcd)	Lichtstrom Luminous Flux I_F = 50 mA Φ_V (mlm)	Bestellnummer Ordering Code
LA E655-V2AB-11	amber	colorless clear	900 … 1800	1600 (typ.)	Q62703-Q5837
LA E655-ABCA-11			1400 … 3550	2900 (typ.)	Q62703-Q5838

*Anm.: -**1**1 gesamter Farbbereich (siehe **Seite 4**)*
*-1**1** gesamter Durchlassspannungsbereich, Lieferung in Einzelgrupppen (siehe **Seite 5**)*

Die Standardlieferform von Serientypen beinhaltet eine untere bzw. eine obere Familiengruppe, die aus nur 3 bzw. 4 Halbgruppen besteht. Einzelne Halbgruppen sind nicht erhältlich.
In einer Verpackungseinheit / Gurt ist immer nur eine Halbgruppe enthalten.

*Note: -**1**1 Total color tolerance range (please see **page 4**)*
*-1**1** Total forward voltage tolerance, delivery in single groups (see **page 5**)*

The standard shipping format for serial types includes a lower or upper family group of 3 or 4 individual groups. Individual half groups are not available.
No packing unit / tape ever contains more than one luminous intensity half group.

Grenzwerte
Maximum Ratings

Bezeichnung **Parameter**	**Symbol** **Symbol**	**Wert** **Value**	**Einheit** **Unit**
Betriebstemperatur Operating temperature range	T_{op}	– 40 … + 100	°C
Lagertemperatur Storage temperature range	T_{stg}	– 40 … + 100	°C
Sperrschichttemperatur Junction temperature	T_j	+ 125	°C
Durchlassstrom Forward current	I_F	70	mA
Stoßstrom Surge current $t \leq 10$ µs, D = 0.1	I_{FM}	0.1	A
Sperrspannung Reverse voltage	V_R	5	V
Leistungsaufnahme Power consumption $T_A \leq 25$ °C	P_{tot}	180	mW
Wärmewiderstand Thermal resistance Sperrschicht/Umgebung Junction/ambient Sperrschicht/Lötpad Junction/soldering point Montage auf PC-Board FR 4 (Padgröße ≥ 16 mm²) mounted on PC board FR 4 (pad size ≥ 16 mm²)	 $R_{th\ JA}$ $R_{th\ JS}$	 300 130	 K/W K/W

Kennwerte (T_A = 25 °C)
Characteristics

Bezeichnung **Parameter**		**Symbol** **Symbol**	**Wert** **Value**	**Einheit** **Unit**
Wellenlänge des emittierten Lichtes Wavelength at peak emission I_F = 50 mA	(typ.)	λ_{peak}	624	nm
Dominantwellenlänge [1] Dominant wavelength I_F = 50 mA	(typ.)	λ_{dom}	617 +7/-5	nm
Spektrale Bandbreite bei 50 % $I_{rel\ max}$ Spectral bandwidth at 50 % $I_{rel\ max}$ I_F = 50 mA	(typ.)	$\Delta\lambda$	18	nm
Abstrahlwinkel bei 50 % I_V (Vollwinkel) Viewing angle at 50 % I_V	(typ.)	2φ	60	Grad deg.
Durchlassspannung [2] Forward voltage I_F = 50 mA	(typ.) (max.)	V_F V_F	2.1 2.5	V V
Sperrstrom Reverse current V_R = 5 V	(typ.) (max.)	I_R I_R	0.01 10	µA µA
Temperaturkoeffizient von λ_{peak} Temperature coefficient of λ_{peak} I_F = 50 mA; –10°C ≤ T ≤ 100°C	(typ.)	$TC_{\lambda peak}$	0.15	nm/K
Temperaturkoeffizient von λ_{dom} Temperature coefficient of λ_{dom} I_F = 50 mA; –10°C ≤ T ≤ 100°C	(typ.)	$TC_{\lambda dom}$	0.08	nm/K
Temperaturkoeffizient von V_F Temperature coefficient of V_F I_F = 50 mA; –10°C ≤ T ≤ 100°C	(typ.)	TC_V	– 1.7	mV/K
Optischer Wirkungsgrad Optical efficiency I_F = 50 mA	(typ.)	η_{opt}	15	lm/W

[1] Wellenlängen werden mit einer Stromeinprägedauer von 25 ms und einer Genauigkeit von ±1 nm ermittelt.
Wavelengths are tested at a current pulse duration of 25 ms and a tolerance of ±1 nm.

[2] Durchlasspannungsgruppen werden mit einer Stromeinprägedauer von 1 ms und einer Genauigkeit von ±0.1 V ermittelt.
Forward voltage groups are tested at a current pulse duration of 1 ms and a tolerance of ±0.1 V.

[2] **Durchlassspannungsgruppen**
Forward voltage groups

Gruppe Group	Durchlassspannung Forward voltage		Einheit Unit
	min.	max.	
3A	1.90	2.05	V
3B	2.05	2.20	V
4A	2.20	2.35	V
4B	2.35	2.50	V

Helligkeits-Gruppierungsschema
Luminous Intensity Groups

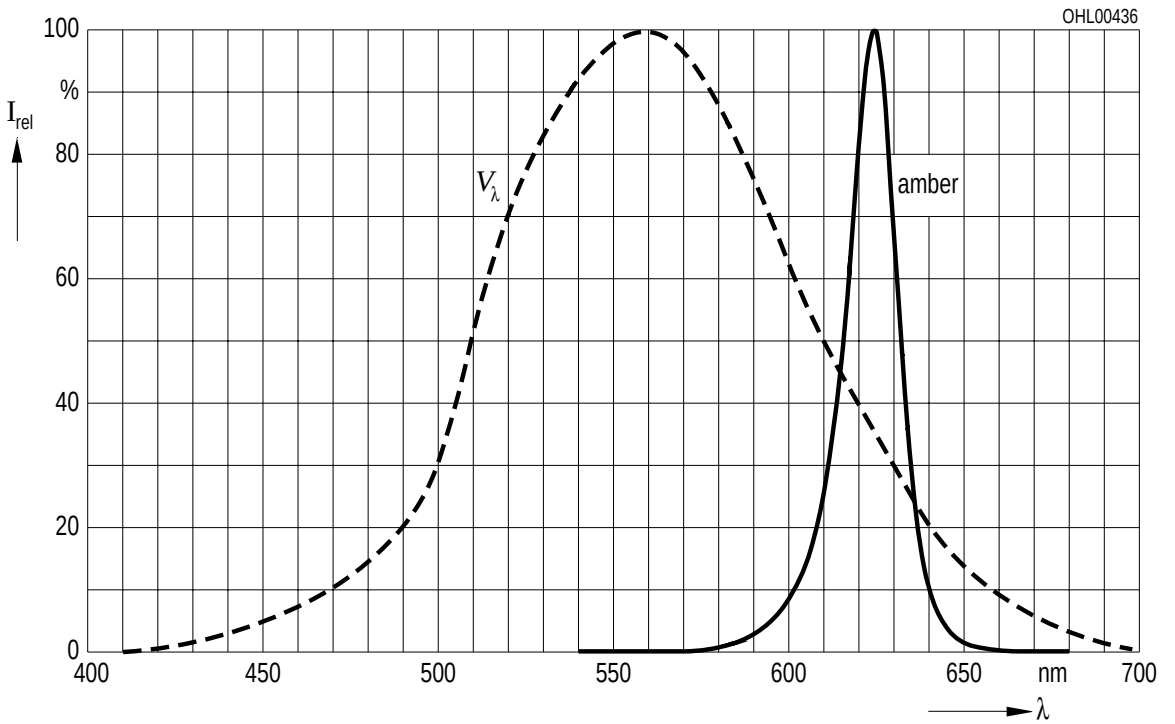
Lichtgruppe Luminous Intensity Group	Lichtstärke Luminous Intensity I_V (mcd)	Lichtstrom Luminous Flux Φ_V (mlm)
V2	900 … 1120	1200 (typ.)
AA	1120 … 1400	1500 (typ.)
AB	1400 … 1800	1900 (typ.)
BA	1800 … 2240	2400 (typ.)
BB	2240 … 2800	3000 (typ.)
CA	2800 … 3550	3700 (typ.)

Helligkeitswerte werden mit einer Stromeinprägedauer von 25 ms und einer Genauigkeit von ± 11% ermittelt.
Luminous intensity is tested at a current pulse duration of 25 ms and a tolerance of ± 11%.

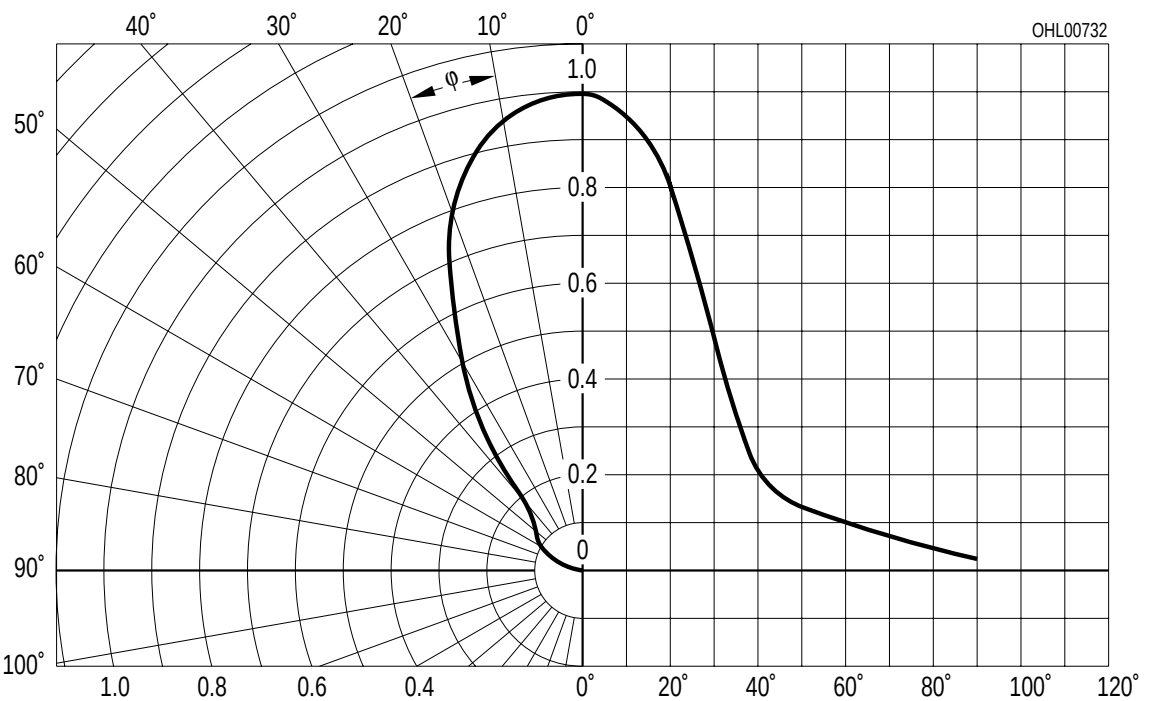
Gruppenbezeichnung auf Etikett
Group Name on Label
Beispiel: AB-13A
Example: AB-13A

Lichtgruppe Luminous Intensity Group	Halbgruppe Half Group	Wellenlänge Wavelength	Durchlassspannung Forward Voltage
A	B	1	3A

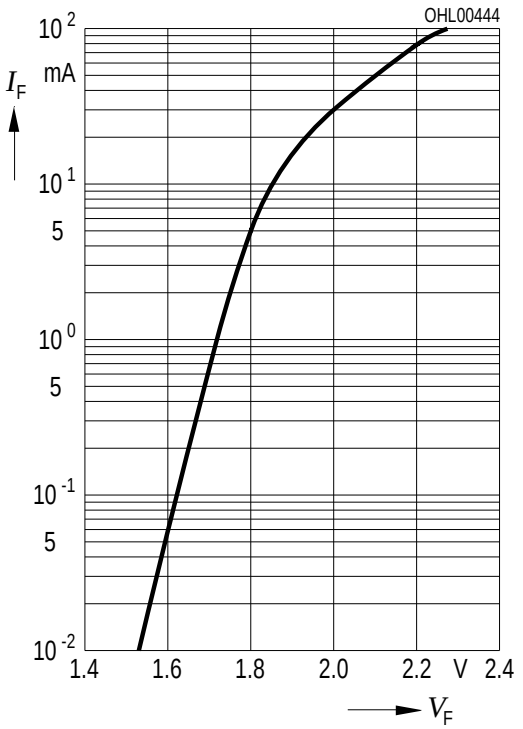
Relative spektrale Emission $I_{rel} = f(\lambda)$, T_A = 25 °C, I_F = 50 mA
Relative Spectral Emission
V(λ) = spektrale Augenempfindlichkeit
Standard eye response curve



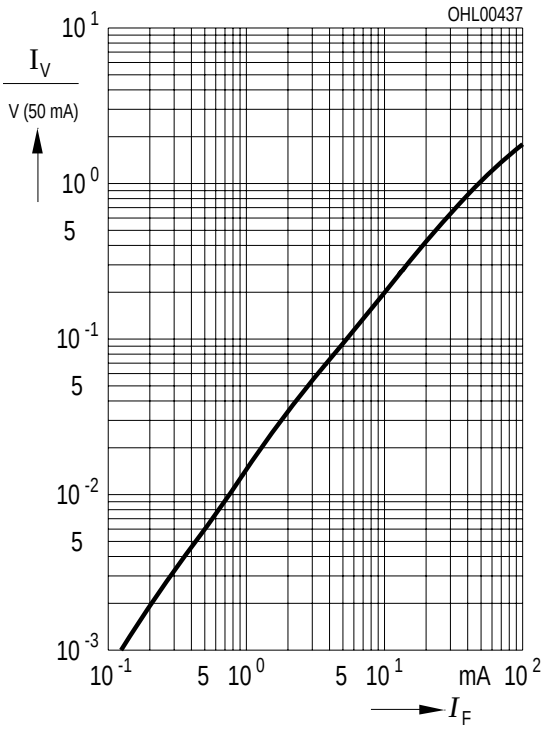
Abstrahlcharakteristik $I_{rel} = f(\varphi)$
Radiation Characteristic



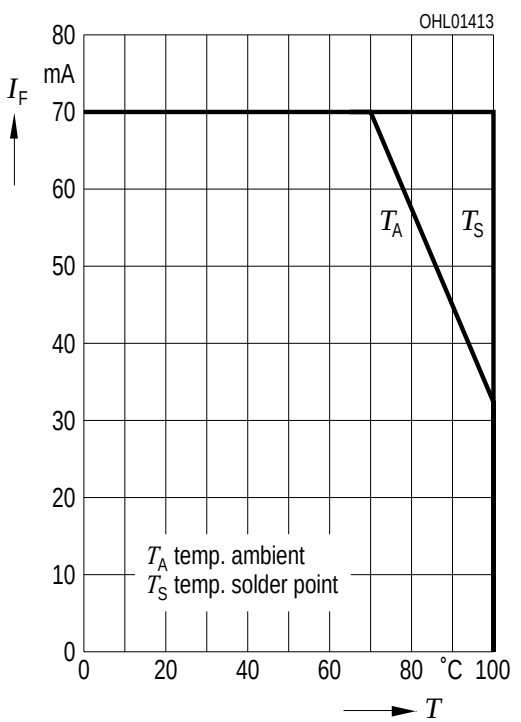
Durchlassstrom $I_F = f(V_F)$
Forward Current
T_A = 25 °C



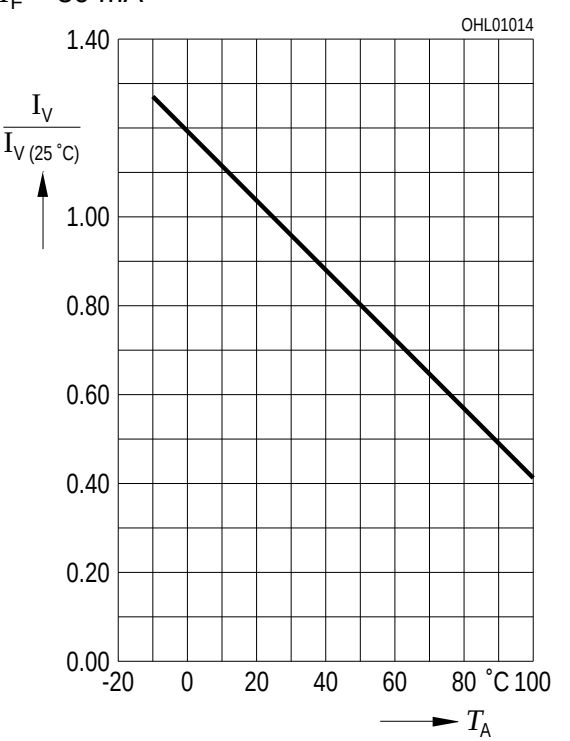
Relative Lichtstärke $I_V/I_{V(50\ mA)} = f(I_F)$
Relative Luminous Intensity
T_A = 25 °C



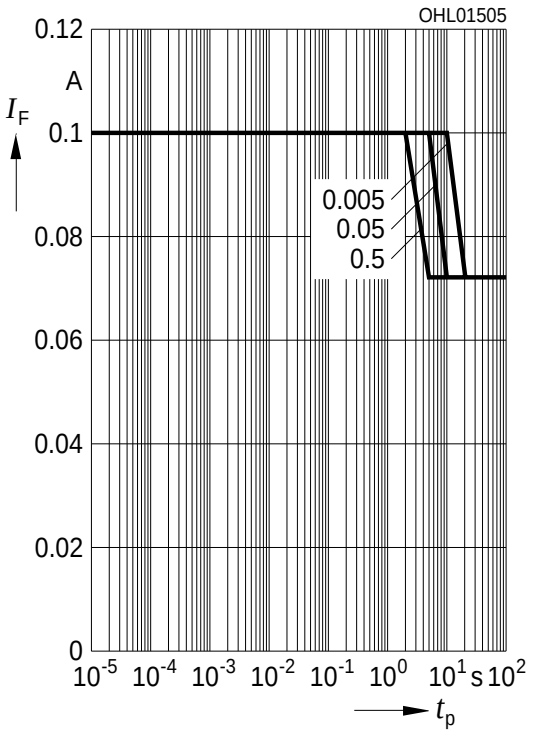
Maximal zulässiger Durchlassstrom $I_F = f(T)$
Max. Permissible Forward Current



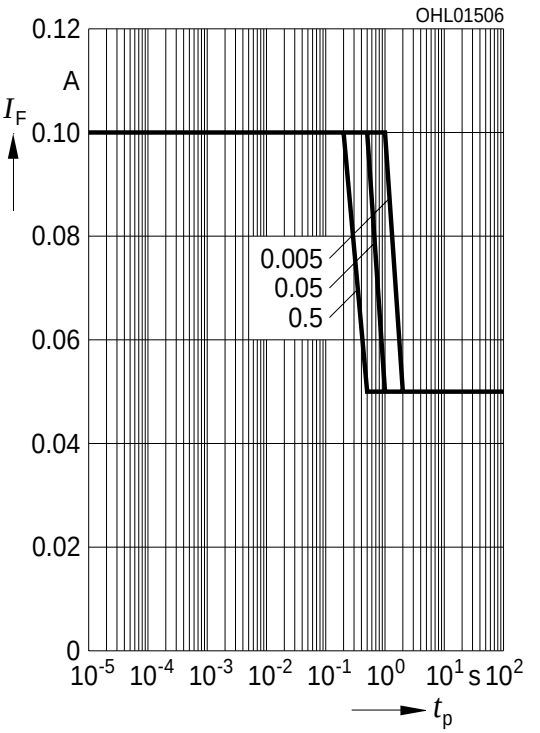
Relative Lichtstärke $I_V/I_{V(25\ °C)} = f(T_A)$
Relative Luminous Intensity
I_F = 50 mA



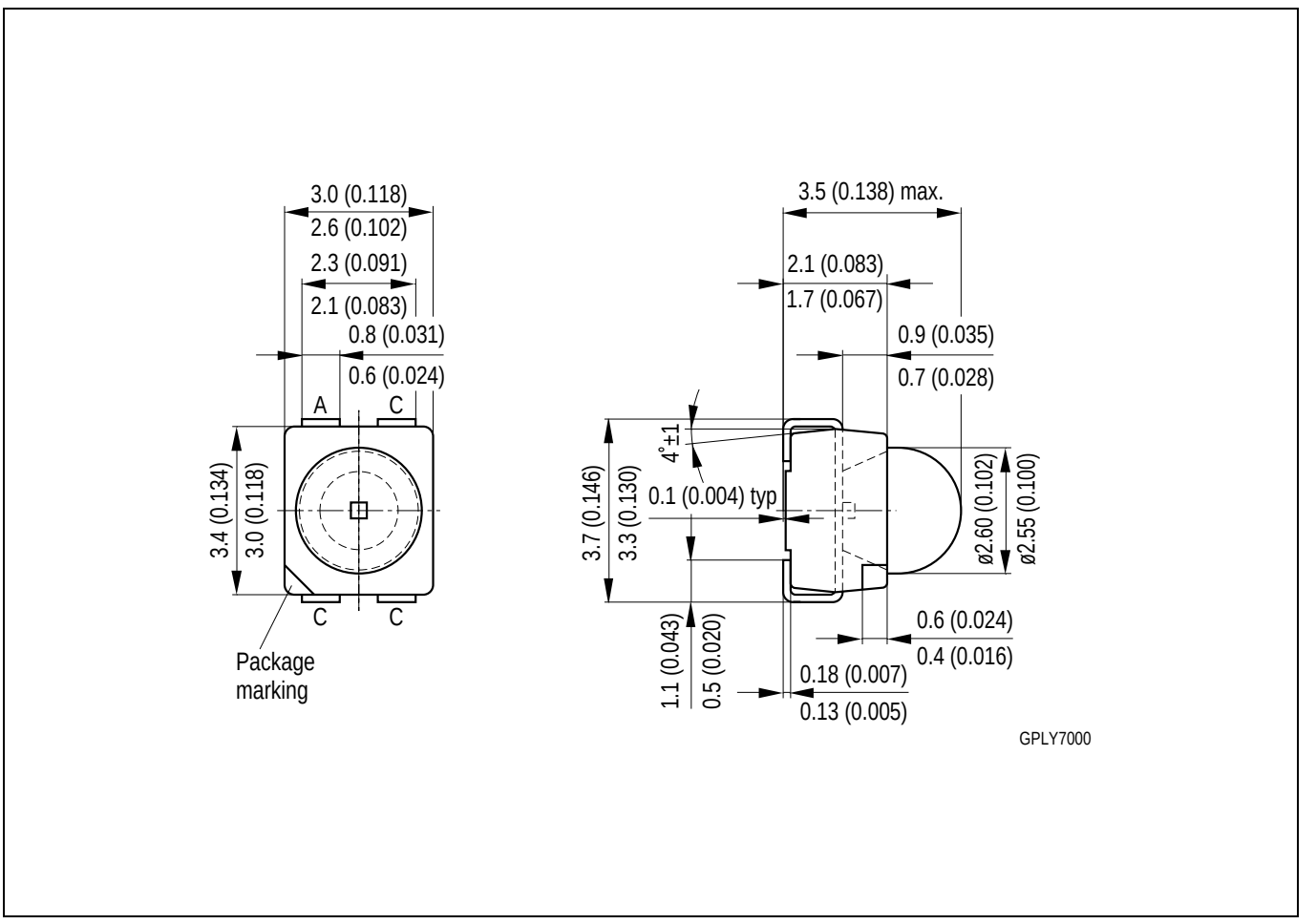
Zulässige Impulsbelastbarkeit $I_F = f(t_p)$
Permissible Pulse Handling Capability
Duty cycle D = parameter, T_A = 25 °C



Zulässige Impulsbelastbarkeit $I_F = f(t_p)$
Permissible Pulse Handling Capability
Duty cycle D = parameter, T_A = 85 °C



Maßzeichnung
Package Outlines

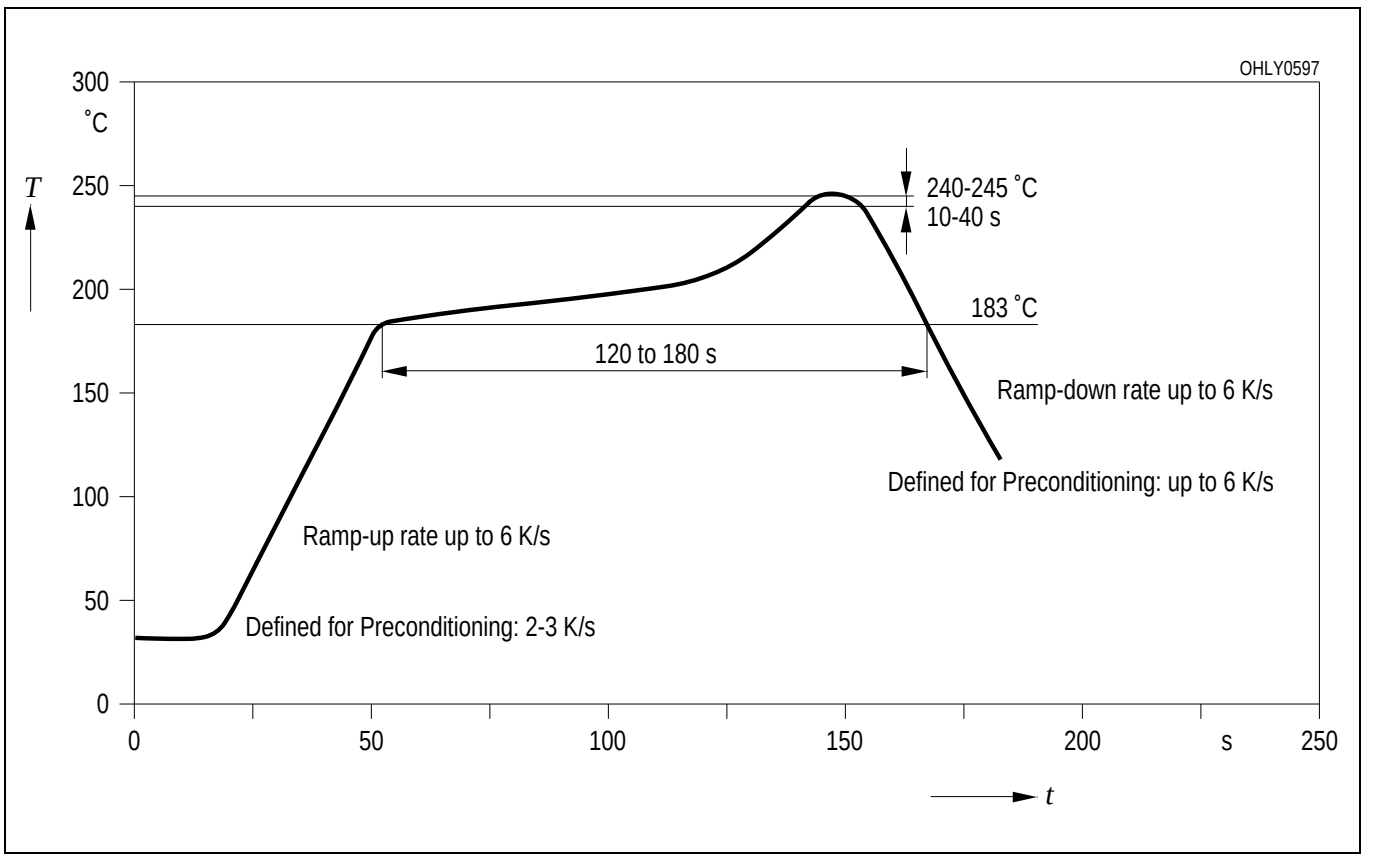


Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).

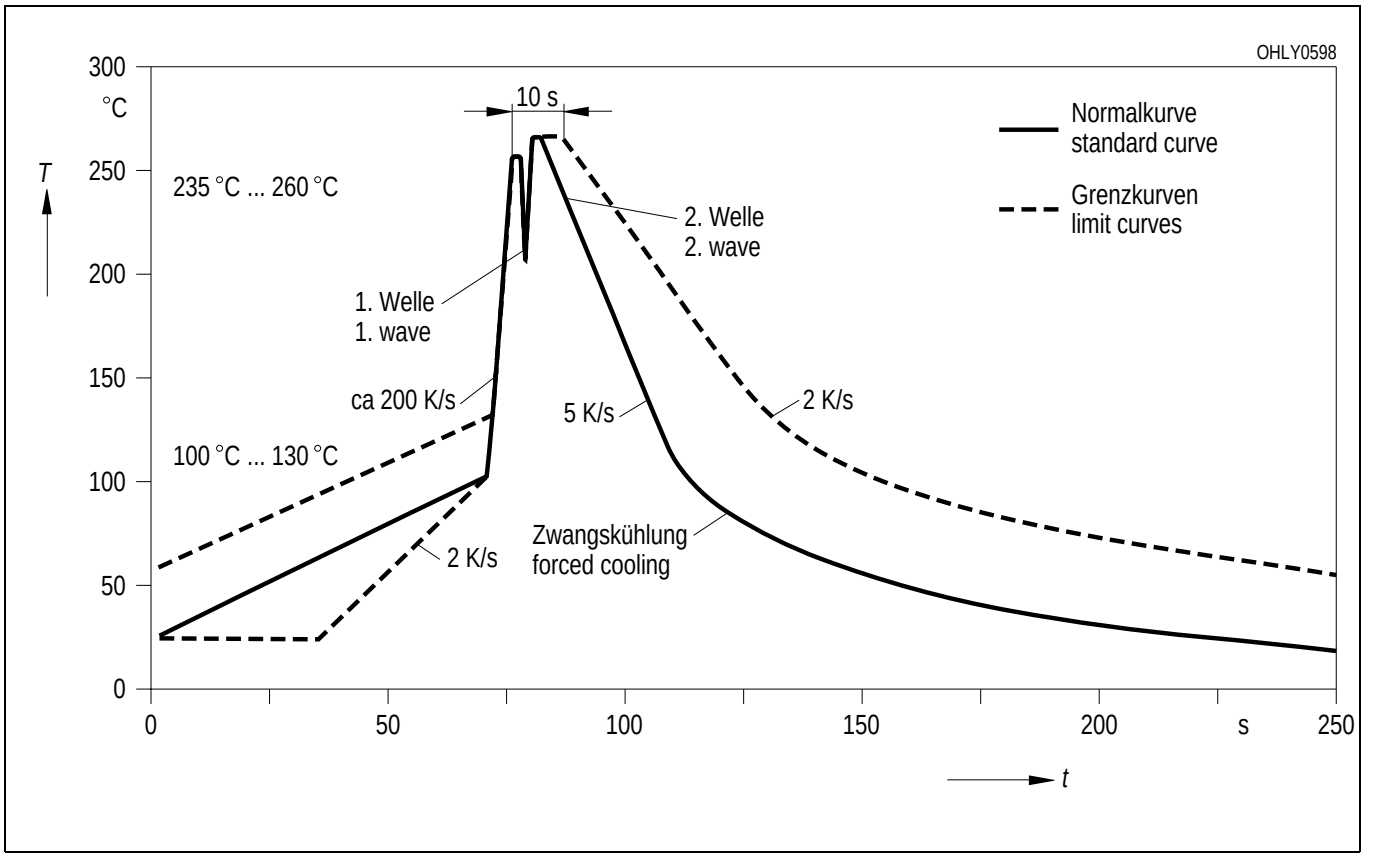
Gewicht / Approx. weight: 38 mg

Lötbedingungen Vorbehandlung nach JEDEC Level 2
Soldering Conditions Preconditioning acc. to JEDEC Level 2

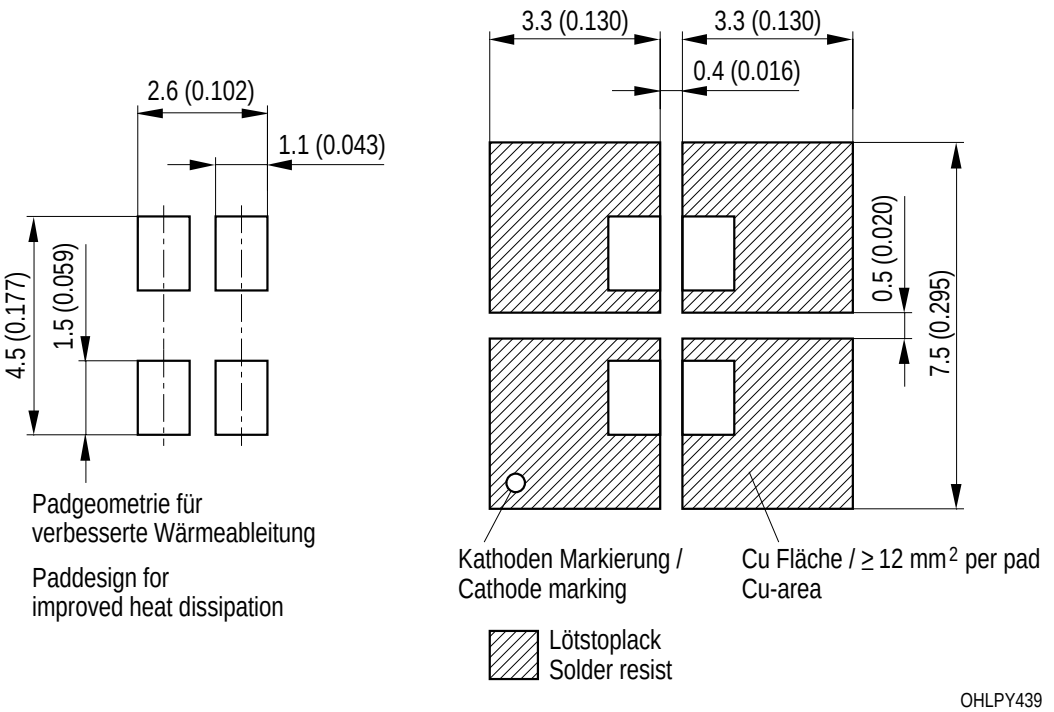
IR-Reflow Lötprofil (nach IPC 9501)
IR Reflow Soldering Profile (acc. to IPC 9501)



Wellenlöten (TTW) (nach CECC 00802)
TTW Soldering (acc. to CECC 00802)

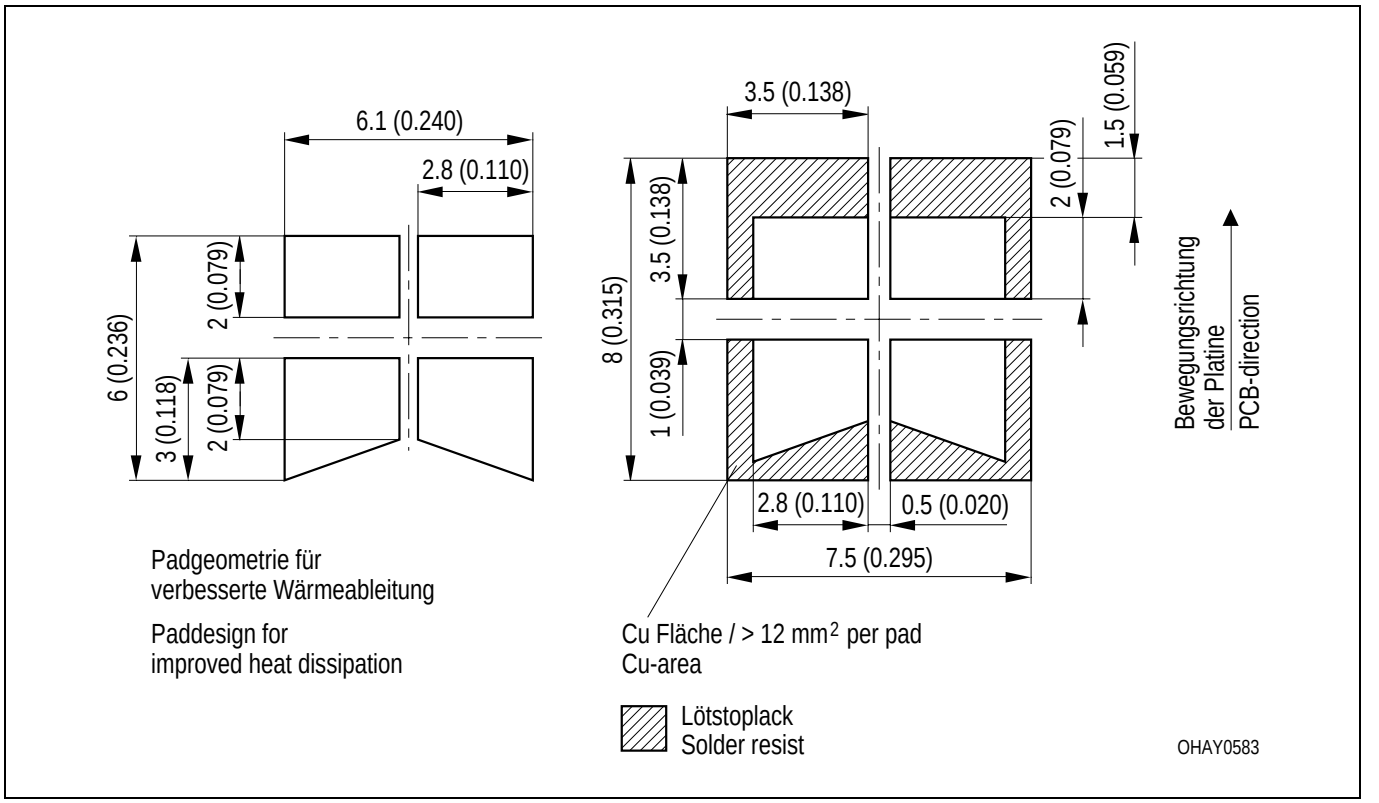


Empfohlenes Lötpaddesign IR Reflow Löten
Recommended Solder Pad IR Reflow Soldering



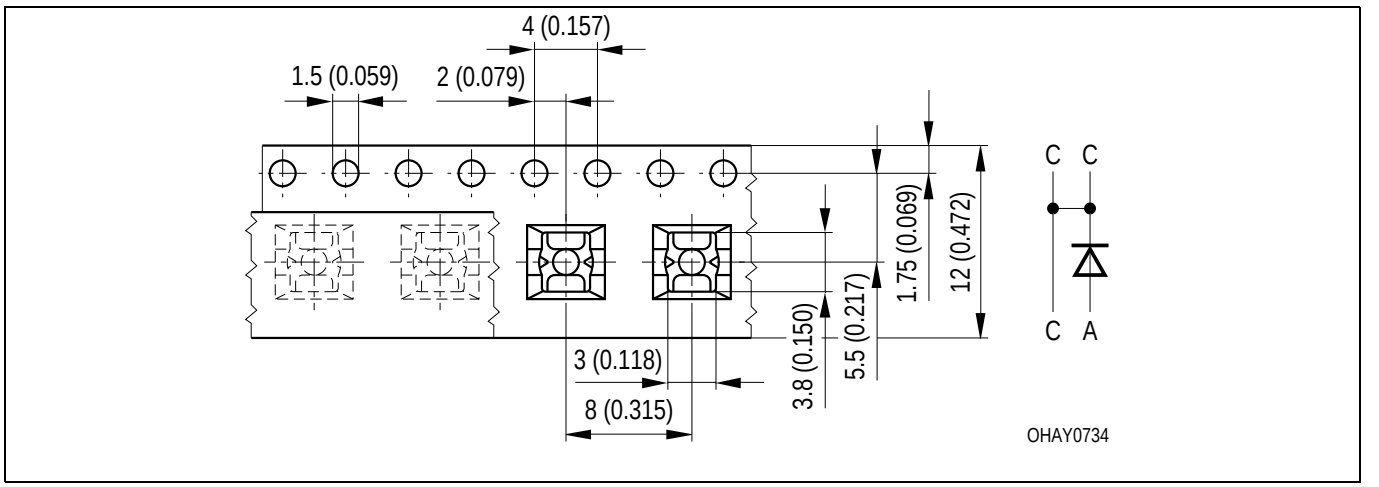
Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).

Empfohlenes Lötpaddesign Wellenlöten (TTW)
Recommended Solder Pad TTW Soldering



Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).

Gurtung / Polarität und Lage Verpackungseinheit 2000/Rolle, ø330 mm
Method of Taping / Polarity and Orientation Packing unit 2000/reel, ø330 mm



Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).

Revision History: 2001-03-05	
Previous Version: 2001-03-05	
Page	**Subjects (major changes since last revision)**

Published by OSRAM Opto Semiconductors GmbH & Co. OHG
Wernerwerkstrasse 2, D-93049 Regensburg
© All Rights Reserved.
Attention please!
The information describes the type of component and shall not be considered as assured characteristics.
Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances. For information on the types in question please contact our Sales Organization.
If printed or downloaded, please find the latest version in the Internet.
Packing
Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.
Components used in life-support devices or systems must be expressly authorized for such purpose! Critical components [1] may only be used in life-support devices or systems [2] with the express written approval of OSRAM OS.
[1] A critical component is a component used in a life-support device or system whose failure can reasonably be expected to cause the failure of that life-support device or system, or to affect its safety or the effectiveness of that device or system.
[2] Life support devices or systems are intended (a) to be implanted in the human body, or (b) to support and/or maintain and sustain human life. If they fail, it is reasonable to assume that the health of the user may be endangered.